



In re Application of:

\*\*\*\*\*

Group Art Unit: 2823

Serial No.: 10/756,122

Confirmation No.: 4554

Filed: January 13, 2004

**Examiner: Julio J. Maldonado**

For: A Low Dielectric Constant  
Film Produced From Silicon  
Compounds Comprising  
Silicon-Carbon Bond

**MAIL STOP AMENDMENT**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**CERTIFICATE OF MAILING**  
37 CFR 1.8

I hereby certify that this correspondence is being deposited on 3/21, 2005 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

3/21/05 *Kia R. [Signature]*  
Date Signature

Dear Sir:

**RESPONSE TO OFFICE ACTION DATED FEBRUARY 23, 2005**

In response to the Office Action dated February 23, 2005, having a shortened statutory period for response set to expire on May 23, 2005, please enter this response and reconsider the claims pending in the application for reasons discussed below. The Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/2592.C7/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Specification** begin on page 2 of this paper. **Amendments to the Claims** are reflected in the listing of claims which begins on page 5 of this paper. **Remarks** begin on page 8 of this paper.